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January 2006

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Unit

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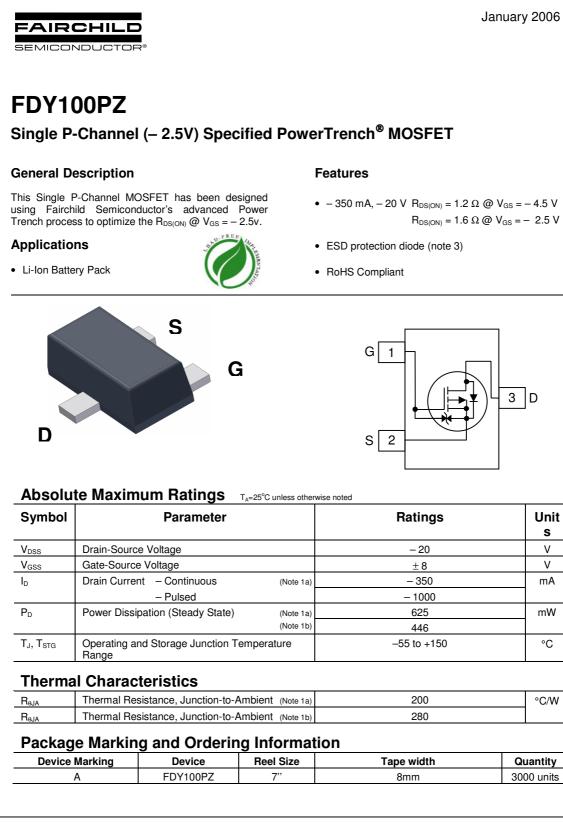
mΑ

mW

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°C/W

FDY100PZ Single P-Channel (– 2.5V) Specified PowerTrench[®] MOSFET

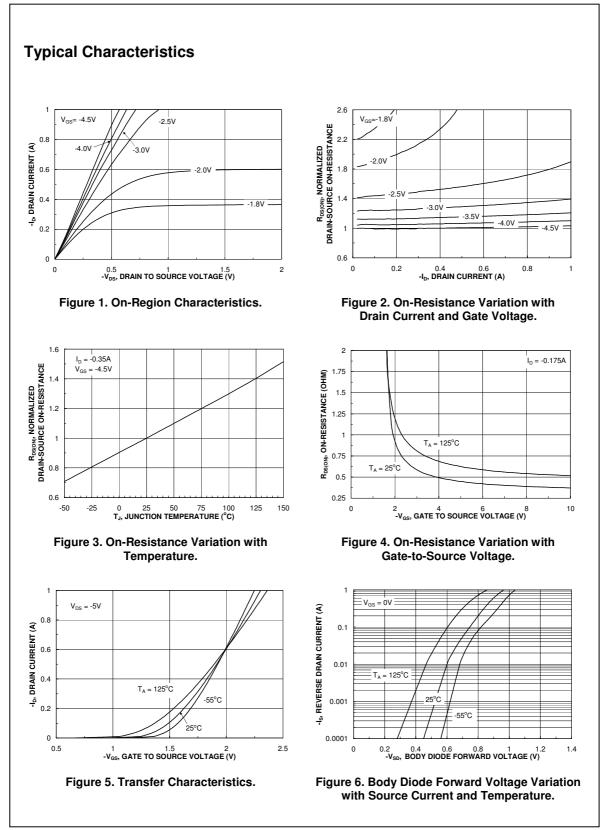


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Parameter			_		
i didificici	Test Conditions	Min	Тур	Мах	Units
cteristics					
Drain–Source Breakdown Voltage	$V_{GS}=0~V, \qquad I_D=-250~\mu A$	- 20			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		15		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			- 3	μA
Gate-Body Leakage,	$V_{\text{GS}} = \pm 8 \text{ V}, \qquad V_{\text{DS}} = 0 \text{ V}$			± 10	μA
Cteristics (Note 2)					
Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = -250 \ \mu\text{A}$	- 0.65	-1.0	- 1.5	V
Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-3		mV/°C
Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=-4.5 \ V, \ I_{D}=-350 \ mA \\ V_{GS}=-2.5 \ V, \ I_{D}=-300 \ mA \\ V_{GS}=-1.8 \ V, \ I_{D}=-150 \ mA \\ V_{GS}=-4.5 \ V, \ I_{D}=-350 \ mA, \\ T_{1}=125^{\circ}C \end{array} $		0.5 0.8 1.3 0.7	1.2 1.6 2.7 1.6	Ω
Forward Transconductance	$V_{DS} = -5 V$, $I_D = -350 mA$		1		S
Characteristics					
	$V_{00} = -10 V$ $V_{00} = 0 V$		100		pF
			30		pF
					pF
· ·					Ρ.
		1	<u> </u>	10	
,			-		ns
	VGS - 4.0 V, HIGEN - 0 12		-	-	ns
,	-		-		ns
					ns
			-	1.4	nC
	VGS - +.5 V				nC
Gate-Drain Charge			0.3		nC
urce Diode Characteristics Drain–Source Diode Forward	and Maximum Ratings $V_{GS} = 0 \text{ V}, I_S = -150 \text{ m A}(\text{Note 2})$		-0.8	- 1.2	V
Voltage					
Diode Reverse Recovery Time					ns
Diode Reverse Recovery Charge	$dI_F/dt = 100 \text{ A}/\mu\text{s}$		2		nC
	Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage, Cteristics (Note 2) Gate Threshold Voltage Coefficient Static Drain-Source On-Resistance Forward Transconductance Characteristics Input Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Drain Charge Irce Diode Characteristics Drain-Source Diode Forward Voltage Diode Reverse Recovery Time	VoltageImage: Second state and the second stat	VoltageImage: Second Seco	VoltageIb $= -250 \mu$ A, Referenced to 25° C15CoefficientIb $= -250 \mu$ A, Referenced to 25° C15CoefficientVois = 0 VIbIbIbGate Outage Drain CurrentVois = 16 V, Vois = 0 VIbGate-Body Leakage,Vois = 18 V, Vois = 0 VIbCateristics(Note 2)IbIbGate Threshold VoltageIb $= 250 \mu$ A, Referenced to 25° CIbGate Threshold VoltageIb $= 250 \mu$ A, Referenced to 25° CIbStatic Drain-SourceVois = -4.5 V, IbIbIbOn-ResistanceVois = -4.5 V, IbIbIbVois = -1.8 V, IbIbIbIbOn-ResistanceVois = -10 V, Vois = 00 MAIbVois = -18 V, IbIbIbIbProward TransconductanceVois = -10 V, Vois = 0 V, IbIbInput CapacitanceVois = -10 V, Vois = 0 V, IbIbInput CapacitanceVois = -10 V, Vois = 0 V, IbIbInput CapacitanceVois = -10 V, Vois = 0 V, IbIbInput CapacitanceVois = -10 V, IbIbIbInum-On Delay TimeVois = -4.5 V, Roien = 6 DIbTurn-On Dialey TimeVois = -4.5 VIbIbInum-Off Fall TimeIbIbIbIndicate ChargeVois = -10 V, IbIbIbGate-Drain ChargeIbIbIbIbDrain-Source ChargeVois = -10 V, IbIbIbIbIndide Characteristics and Maxim	VoltageImage ConstraintImage ConstraintBreakdown Voltage Temperature CoefficientIp = - 250 μ A, Referenced to 25°C15Zero Gate Voltage Drain CurrentVDS = - 16 V, VGS = 0 V-3Gate-Body Leakage,VGS = ± 8 V, VDS = 0 V± 10Cheristics Constraint ConstraintVDS = - 16 V, VGS = 0 V-3Gate Threshold Voltage Temperature CoefficientIp = 250 μ A, Referenced to 25°C-3Static Drain-Source On-ResistanceVGS = -4.5 V, Ip = -350 mA VGS = -4.5 V, Ip = -350 mA0.51.2On-ResistanceVGS = -4.5 V, Ip = -350 mA VGS = -4.5 V, Ip = -350 mA0.71.6Turn-On-ResistanceVDS = -10 V, VGS = 0 V, T = 1.612Proward TransconductanceVDS = -10 V, VGS = 0 V, T = 1.0 MHz100Characteristics Turn-On Delay Time Turn-Off Ball TimeVDS = -10 V, VGS = 0 V, Turn-Off Fall Time12Total Gate Charage Gate-Source Charge Gate-Drain ChargeVDS = -10 V, Ip = -0.5 A, VGS = -4.5 V, GS = -4.5 V, Ip = -350 mA,1.01.4Indicate Charge Gate-Drain ChargeVDS = -10 V, Ip = -0.5 A, VGS = -4.5 V, GS = -4.5 V, GS = -4.5 V, GS = -4.5 V,0.213Intra-Off Fall Time Turn-Off Fall Time120.21Interce Charge Gate-Drain ChargeVDS = -10 V, Ip = -350 mA, US = -4.5 V,0.21.1Interce Charge Gate-Drain ChargeVDS = -10 V, Ip = -350 mA, US = -4.5 V,1.01.4Interce Charge Otal Gate CharacteristicsInterce Charge US = -4.5 V,

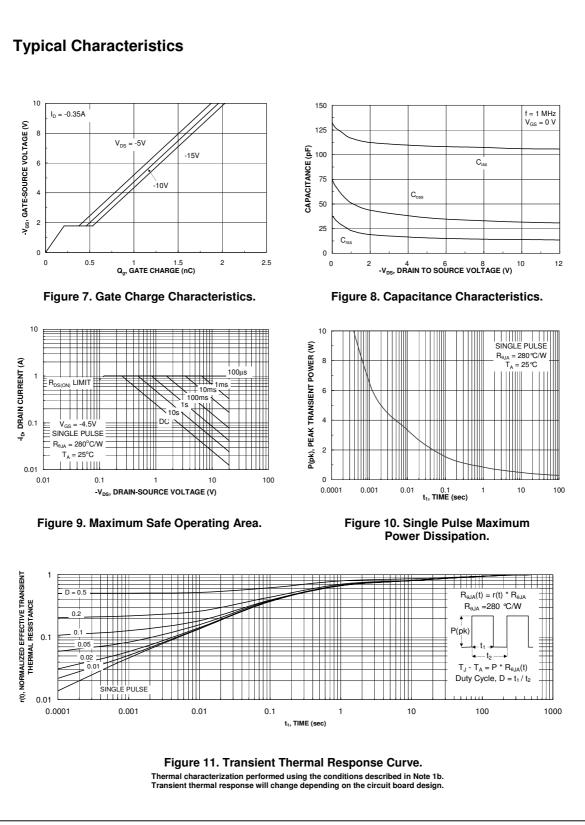
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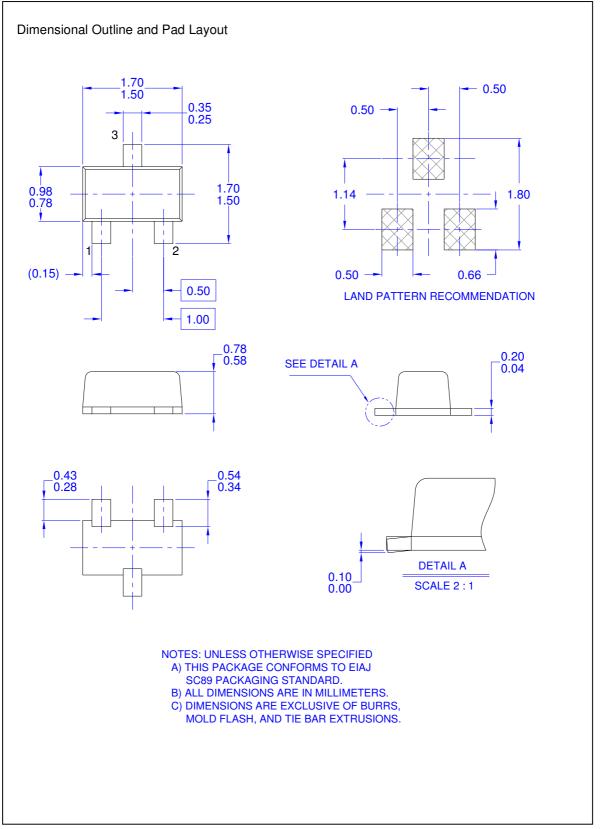


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